

# TerraGreen® 400G (RF/MW)

Halogen-free, Extremely Low Loss Material

UL - File E41625 Grade PCL-FR-370HR IPC-4101 /134

TerraGreen® 400G laminate materials are our most advanced ultra high speed, halogen free ultra low loss design solutionnargap.

#### **PRODUCT FEATURES**

**Industry Recognition** 

- UL File Number: E41625
- RoHS Compliant

Performance Attributes

- CAF resistant
- Lead-free assembly compatible
- 6x 260°C reflow capable
- 6x 288°C solder float capable

**Processing Advantages** 

- FR-4 process compatible
- Excellent fill and flow for heavy
- Multiple lamination cycles
- HDI technology compatible

# PRODUCT AVAILABILITY

Standard Material Offering: Laminate

- 2 to 20 mil (0.05 to 0.51 mm) Copper Foil Type
- HVLP3 (VLP1) ≤1.1 micron Rz JIS Copper Weight
- $\frac{1}{2}$ , 1 oz (18 and 35  $\mu$ m) available Standard Material Offering: Prepreg Glass Fabric Availability
  - Low Dk glass
  - Square weave glass
  - Mechanically spread glass

# **ORDERING INFORMATION:**

Contact your local sales representative or contact info@isola-group.com for further information.

TerraGreen® 400G (RF/MW) is our Halogen Free material solution for next generation 5G infrastructure and mmWave applications. Our novel resin system has been engineered for high data rates with excellent cost for loss performance.

TerraGreen® 400G (RF/MW) is lead free compatible and can be processed utilizing standard PCB equipment and processing steps.

TerraGreen® 400G (RF/MW) meets UL 94 V-0 and is halogen free.

## PRODUCT ATTRIBUTES







## TYPICAL MARKET APPLICATIONS







#### Isola Group

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#### Isola Asia Pacific

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#### Isola GmbH

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# **Typical Values Table**

Property		Typical Value	Units	Test Method
			Metric (English)	IPC-TM-650 (or as noted)
Glass Transition Temperature (Tg) by DSC		200	°C	2.4.25C
Glass Transition Temperature (Tg) by DMA		215	_	2.4.24.4
Glass Transition Temperature (Tg) by TMA		180	°C	2.4.24C
Decomposition Temperature (Td) by TGA @ 5% weight loss		>380	°C	2.4.24.6
Time to Delaminate by TMA (Copper removed)	T288	60+	Minutes	2.4.24.1
Z-Axis CTE	A. Pre-Tg B. Post-Tg C.	37 170 1.8	ppm/°C	2.4.24C
X/Y-Axis CTE		12/13	ppm/°C	2.4.24C
Thermal Conductivity		0.54	W/m·K	ASTM E1952
Thermal Stress 10 sec @ 288°C (550.4°F)	A. Unetched B. Etched	Pass	Pass Visual	2.4.13.1
Dk, Permittivity	A. @ 5 GHz B. @ 10 GHz C. @ 20 GHz	3.07	_	2.5.5.5
Df, Loss Tangent	A. @ 5 GHz B. @ 10 GHz C. @ 20 GHz	0.0018	_	Bereskin Stripline
Peel Strength		0.7 (4.1)	N/mm (lb/inch)	2.4.8C
Flammability (Laminate & laminated prepreg)		V-0	Rating	UL 94
Relative Thermal Index (RTI)		140	°C	_

# **NOTES**

Notes:

All data is preliminary and subject to chaange

\* Data was developed using 55% RC rigid laminate

Revisions:

A: Preliminary Release

B-Corrected CTE data-5/24

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